## **VARAD LAD**

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#### **SUMMARY**

5 years of experience in mechanical design, optimizing thin-film/vacuum deposition equipment, opto-electronics/display and owning critical systems across semiconductor fabs & data centers, set up & troubleshot (8D, FMEA) high-vacuum assemblies integrating CAD

#### **WORK EXPERIENCE**

## TSMC | Mechanical Engineer, Facilities | Critical Facilities Systems | Phoenix, AZ

Jul 2024 - May 2025

- Delivered 4nm, 2nm semiconductor fab build; designed and installed vacuum deposition system as a lead mechanical engineer
- Saved \$120,000 in maintenance costs by troubleshooting vacuum issues via design modification and a N+1 redundancy plan
- Reduced downtime by 25% by diagnosing real-time critical thin-film and vacuum system failure issues across the production line
- Troubleshot critical environment-cleanroom mechanical systems, cooling towers, RCTO, chillers, and validated, P&IDs, & PFDs
- Built code compliant installation schedule following ICC, IBC, IMC, IFC and NFPA codes; passed inspection with 0% rework
- Developed Power Bi and Tableau dashboards to streamline contractor milestones, commissioning, design submittals and city code reviews, which improved project timelines and enhanced stakeholder collaboration during mechanical package review

### Rayn Innovation | Senior Opto-Mechanical Engineer Intern | R&D, Hardware & Thermal Test | Tempe, AZ

Jan 2024 – May 2024

- Boosted display-packaging hardware performance & electric conductivity by synthesizing thin film via CVD, PVD, ALD techniques
- Detected 90% of surface defects in nano thin-film by performing metrology on microstructure using SEM, TEM, XRD, and UV-Vis
- Increased film uniformity by 12% and reduced material waste by 40%, by optimizing process parameters using DOE & SPC in JMP
- Tested hardware and thermal properties of wafer-level packaging using controlled heating and sensor-based feedback systems
- Drove 28% yield performance gain of the product prototypes by enhancing thermal management through parameter tuning
- Improved synthesis-stage purity by 15% through big-data analysis of deposition variables and defect trends using JMP and Python

## Marketech International Corporation | Mechanical Engineer Intern | Tool Interconnect | Phoenix, AZ

Jun 2023 – Aug 2023

- Designed and improved utility connection reliability from 82% to 94% for 15 installed semiconductor critical-facility system tools
- Reduced system downtime by 15% through effective troubleshooting of mechanical system in critical fab environment
- · Resolved BIM system clashes and verified HVAC chillers and duct-system models in Revit, significantly reducing installation issues

# NASA | Mechanical Project Engineer Intern | NASA L'SPACE Program | Tempe, AZ

Aug 2022 – Dec 2022

- Modeled and tested 40 CAD mechanical parts using Siemens NX, approved 7+ patentable projects and authored project proposals
- Identified 10 KPIs of each project in collaboration with NASA Marshall Chief Technologist, resulting in 15% project improvement
- Collaborated with aerospace engineering and chief scientists to develop system concepts for NASA mission simulation projects

## Chemtech Systems | Senior Mechanical Engineer | High-Volume Manufacturing | India

Jun 2019 - May 2022

- Led a team of 5 technicians in a 24/7 high-volume blade manufacturing plant to meet daily production and procurement targets
- Saved approximately \$30,000 and reduced tool downtime by outsourcing predictive maintenance for the critical equipment
- Increased cutting performance by 80% by identifying wear patterns and redesigning blades for self-sharpening functionality
- Saved \$18,000 on the product testing costs by outsourcing final testing and commissioning to third-party contractors
- Applied FMEA methodology to identify and troubleshoot production defects in equipment during high-volume manufacturing
- Reduced annual BOM spend 18%, equivalent to \$300,000 by building an ERP that auto-generated BOMs from CAD drawing and algorithmically ranked regional suppliers on cost, quality and certification, cutting sourcing cycle time by 66%

#### **PROJECTS**

#### Data Center Thermal Management System for Scalable Cooling Optimization

• Improved cooling performance by 27% and reduced hotspots by 32% by simulating liquid vs air-cooling in SimScale using a Fusion 360-designed DC server hall, optimized VRF airflow zoning and adaptive fan control to benchmark efficiency across both methods

## Microsoft Underwater Data Center, Project Natick-inspired Land-Based Data Center Cooling Pod

• Improved land-based data center thermal reliability by 25% and projected a 35–40% reduction in hardware failure rate by designing and simulating sealed, nitrogen-cooled pod environments modeled on Microsoft's Project Natick, underwater data centers

## **TECHNICAL SKILLS & LEADERSHIP**

Vacuum & Thin-Film Tools: PVD, CVD, ALD, PECVD, high-vacuum chambers, leak testing, RGA, wafer-level and display packaging system CAD Design & Simulation: Revit, Siemens NX, ANSYS (CFD & FEA), AutoCAD, SolidWorks, CATIA, Creo, Fusion 360, SimScale Data Analysis, Coding & BI Tools: Python, MATLAB, JMP, SQL, DoE, SPC, Power BI, Tableau, RCA, FMEA, SAP HANA, PLC, HMI, G-code

#### **EDUCATION**